

IRS21091(S)PbF

HALF-BRIDGE DRIVER

Features

- Floating channel designed for bootstrap operation
- Fully operational to +600 V
- Tolerant to negative transient voltage, dV/dt immune
- Gate drive supply range from 10 V to 20 V
- Undervoltage lockout for both channels
- 3.3 V, 5 V, and 15 V input logic compatible
- Cross-conduction prevention logic
- Matched propagation delay for both channels
- High-side output in phase with IN input
- Logic and power ground +/- 5 V offset
- Internal 500 ns deadtime, and programmable up to 5 μ s with one external R_{DT} resistor
- Lower di/dt gate driver for better noise immunity
- The dual function DT/SD input turns off both channels
- RoHS compliant

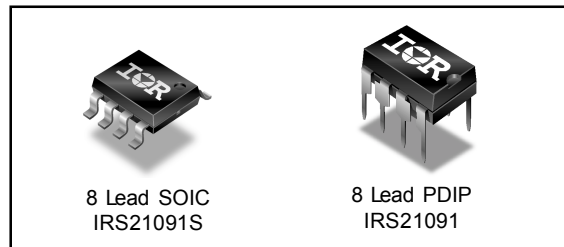
Description

The IRS21091 is a high voltage, high speed power MOSFET and IGBT driver with dependent high- and low-side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3 V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high-side configuration which operates up to 600 V.

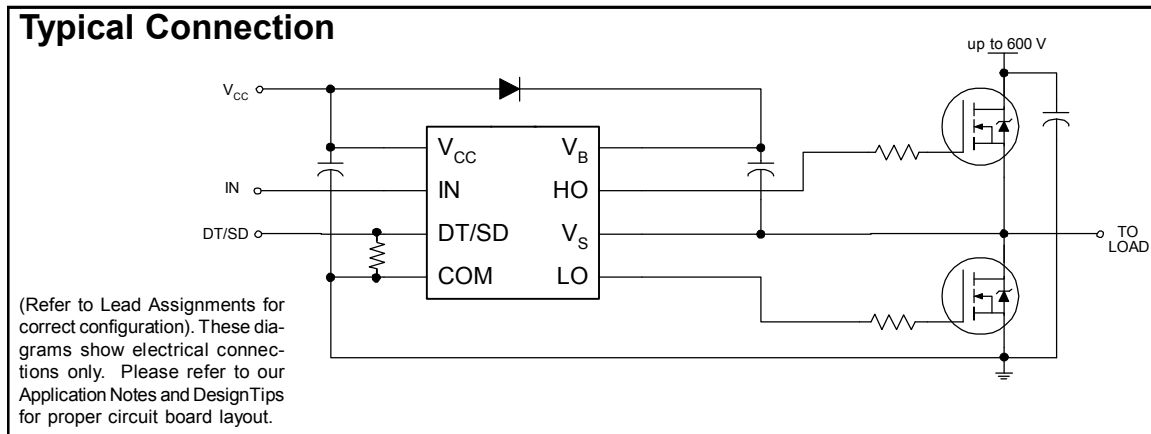
Product Summary

V _{OFFSET}	600 V max.
I _{O+/-}	120 mA / 250 mA
V _{OUT}	10 V - 20 V
t _{on/off} (typ.)	750 ns & 200 ns
Deadtime	540 ns

Packages



Typical Connection



Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min.	Max.	Units	
V_B	High-side floating absolute voltage	-0.3	625	V	
V_S	High-side floating supply offset voltage	$V_B - 25$	$V_B + 0.3$		
V_{HO}	High-side floating output voltage	$V_S - 0.3$	$V_B + 0.3$		
V_{CC}	Low-side and logic fixed supply voltage	-0.3	25		
V_{LO}	Low-side output voltage	-0.3	$V_{CC} + 0.3$		
DT/SD	Programmable deadtime and shutdown pin voltage	$V_{SS} - 0.3$	$V_{CC} + 0.3$		
V_{IN}	Logic input voltage (IN & DT/SD)	$V_{SS} - 0.3$	$V_{CC} + 0.3$		
dV_S/dt	Allowable offset supply voltage transient	—	50	V/ns	
P_D	Package power dissipation @ $T_A \leq +25\text{ }^\circ\text{C}$	(8 Lead PDIP)	—	1.0	W
		(8 Lead SOIC)	—	0.625	
R_{thJA}	Thermal resistance, junction to ambient	(8 Lead PDIP)	—	125	$^\circ\text{C/W}$
		(8 Lead SOIC)	—	200	
T_J	Junction temperature	—	150	$^\circ\text{C}$	
T_S	Storage temperature	-50	150		
T_L	Lead temperature (soldering, 10 seconds)	—	300		

Recommended Operating Conditions

The input/output logic timing diagram is shown in Fig.1. For proper operation the device should be used within the recommended conditions. The V_S offset rating is tested with all supply biased at a 15 V differential.

Symbol	Definition	Min.	Max.	Units
V_B	High-side floating supply absolute voltage	$V_S + 10$	$V_S + 20$	V
V_S	High-side floating supply offset voltage	(Note 1)	600	
V_{HO}	High-side floating output voltage	V_S	V_B	
V_{CC}	Low-side and logic fixed supply voltage	10	20	
V_{LO}	Low-side output voltage	0	V_{CC}	
V_{IN}	Logic input voltage (IN & DT/SD)	V_{SS}	V_{CC}	
DT/SD	Programmable deadtime and shutdown pin voltage	V_{SS}	V_{CC}	
T_A	Ambient temperature	-40	125	°C

Note 1: Logic operational for V_S of -5 V to +600 V. Logic state held for V_S of -5 V to $-V_{BS}$. (Please refer to the Design Tip DT97-3 for more details).

Dynamic Electrical Characteristics

$V_{BIAS} (V_{CC}, V_{BS}) = 15 \text{ V}$, $C_L = 1000 \text{ pF}$, $T_A = 25 \text{ °C}$, unless otherwise specified.

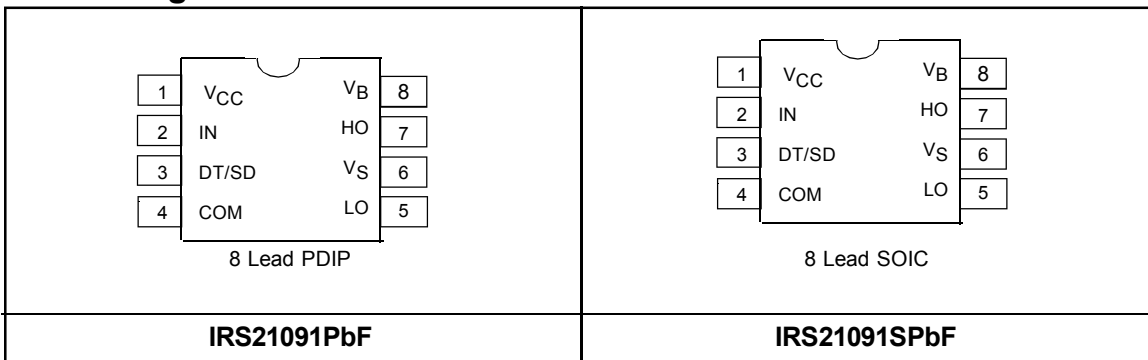
Symbol	Definition	Min.	Typ.	Max.	Units	Test Conditions
t_{on}	Turn-on propagation delay	—	750	950	ns	$V_S = 0 \text{ V}$
t_{off}	Turn-off propagation delay	—	200	280		$V_S = 0 \text{ V}$ or 600 V
t_{sd}	Shutdown propagation delay	—	550	715		$V_S = 0 \text{ V}$
MT	Delay matching, HS & LS turn-on/off	—	0	70		
t_r	Turn-on rise time	—	100	220		
t_f	Turn-off fall time	—	35	80		
DT	Deadtime: LO turn-off to HO turn-on(DT _{LO-HO}) & HO turn-off to LO turn-on (DT _{HO-LO})	400	540	680	μs	$R_{DT} = 0 \Omega$
		4	5	6		$R_{DT} = 200 \text{ k}\Omega$
MDT	Deadtime matching = DT _{LO - HO} - DT _{HO-LO}	—	0	60	ns	$R_{DT} = 0 \Omega$
		—	0	600		$R_{DT} = 200 \text{ k}\Omega$

Static Electrical Characteristics

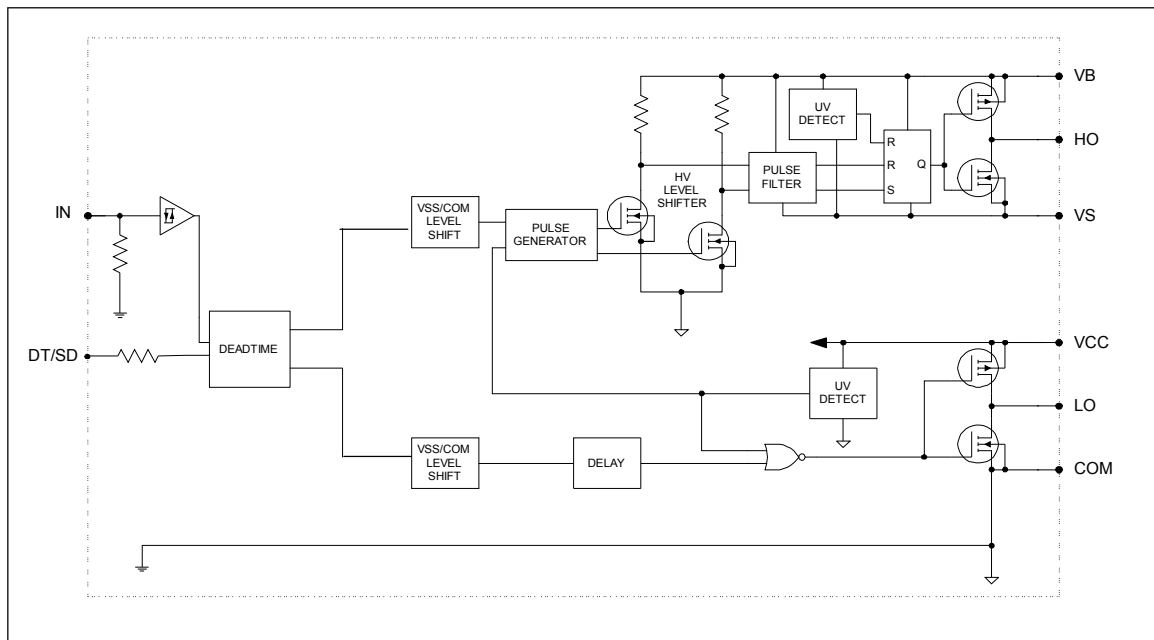
V_{BIAS} (V_{CC} , V_{BS}) = 15 V, and T_A = 25 °C unless otherwise specified. The V_{IL} , V_{IH} , and I_{IN} parameters are referenced to COM and are applicable to the respective input leads: IN and DT/SD. The V_O , I_O , and R_{ON} parameters are referenced to COM and are applicable to the respective output leads: HO and LO.

Symbol	Definition	Min.	Typ.	Max.	Units	Test Conditions
V_{IH}	Logic "1" input voltage for HO & logic "0" for LO	2.5	—	—	V	$V_{CC} = 10\text{ V to }20\text{ V}$
V_{IL}	Logic "0" input voltage for HO & logic "1" for LO	—	—	0.8		
$V_{SD,TH}$	DT/SD input threshold	11.5	13	14.5		
V_{OH}	High level output voltage, $V_{BIAS} - V_O$	—	0.05	0.2		
V_{OL}	Low level output voltage, V_O	—	0.02	0.1		
I_{LK}	Offset supply leakage current	—	—	50	μA	$V_B = V_S = 600\text{ V}$
I_{QBS}	Quiescent V_{BS} supply current	20	75	130		$I_N = 0\text{ V or }5\text{ V}$
I_{QCC}	Quiescent V_{CC} supply current	0.4	1.0	1.6	mA	$I_N = 0\text{ V or }5\text{ V}$ $R_{DT} = 0\ \Omega$
I_{IN+}	Logic "1" input bias current	—	5	20	μA	$I_N = 5\text{ V, DT/SD} = 0\text{ V}$
I_{IN-}	Logic "0" input bias current	—	—	5		$I_N = 0\text{ V, DT/SD} = 5\text{ V}$
V_{CCUV+} V_{BSUV+}	V_{CC} and V_{BS} supply undervoltage positive going threshold	8.0	8.9	9.8	V	
V_{CCUV-} V_{BSUV-}	V_{CC} and V_{BS} supply undervoltage negative going threshold	7.4	8.2	9.0		
V_{CCUVH} V_{BSUVH}	Hysteresis	0.3	0.7	—		
I_{O+}	Output high short circuit pulsed current	120	290	—	mA	$V_O = 0\text{ V, PW} \leq 10\ \mu\text{s}$
I_{O-}	Output low short circuit pulsed current	250	600	—		$V_O = 15\text{ V, PW} \leq 10\ \mu\text{s}$

Lead Assignments



Functional Block Diagrams



Lead Definitions

Symbol	Description
IN	Logic input for high-side and low-side gate driver outputs (HO and LO), in phase with HO
DT/SD	Programmable deadtime lead, disables input/output logic when tied to V _{CC}
V _B	High-side floating supply
HO	High-side gate drive output
V _S	High-side floating supply return
V _{CC}	Low-side and logic fixed supply
LO	Low-side gate drive output
COM	Low-side return

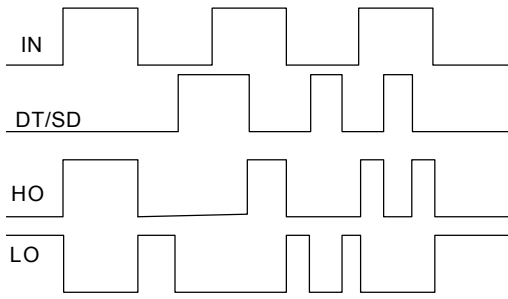


Figure 1. Input/Output Timing Diagram

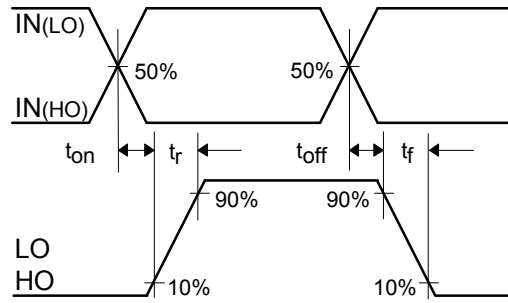


Figure 2. Switching Time Waveform Definitions

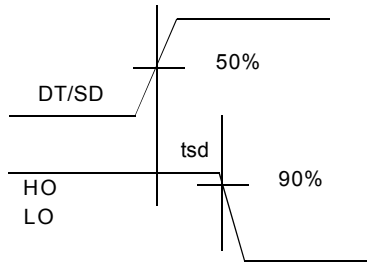


Figure 3. Shutdown Waveform Definitions

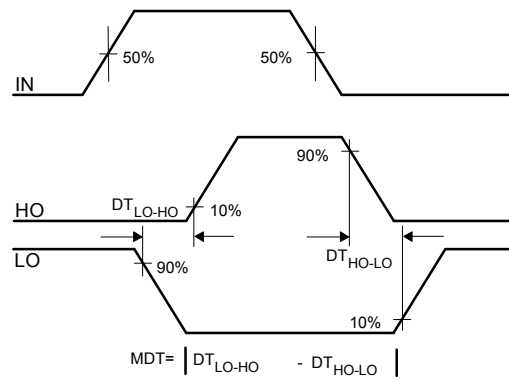


Figure 4. Deadtime Waveform Definitions

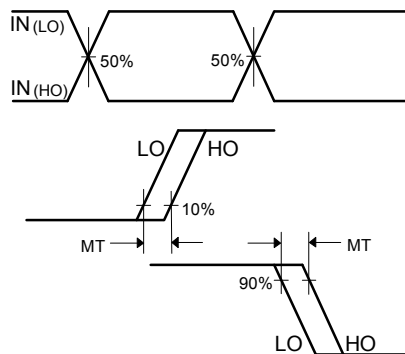


Figure 5. Delay Matching Waveform Definitions

Note: For the following figures the V_{BIAS} (V_{CC} , V_{BS}) = 15 V and $T_A = 25^\circ\text{C}$ unless otherwise specified.

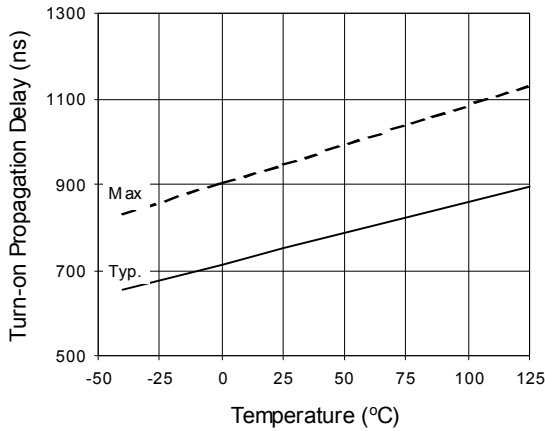


Figure 6A. Turn-On Propagation Delay vs. Temperature

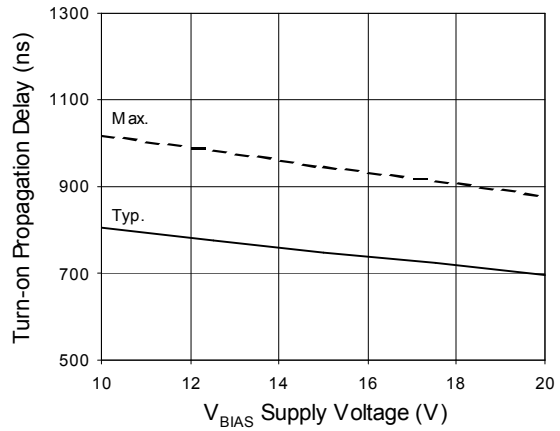


Figure 6B. Turn-On Propagation Delay vs. Supply Voltage

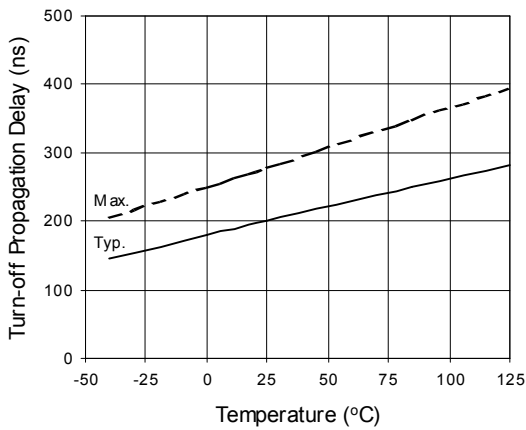


Figure 7A. Turn-Off Propagation Delay vs. Temperature

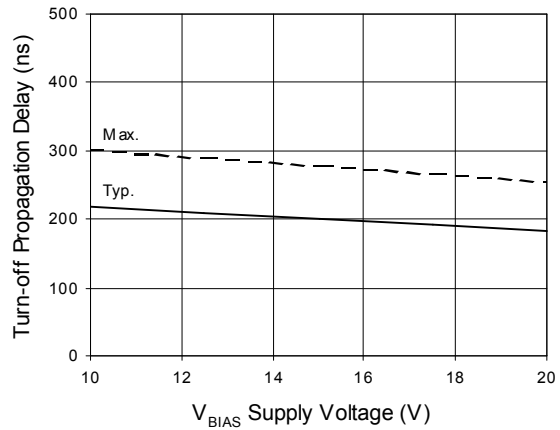


Figure 7B. Turn-Off Propagation Delay vs. Supply Voltage

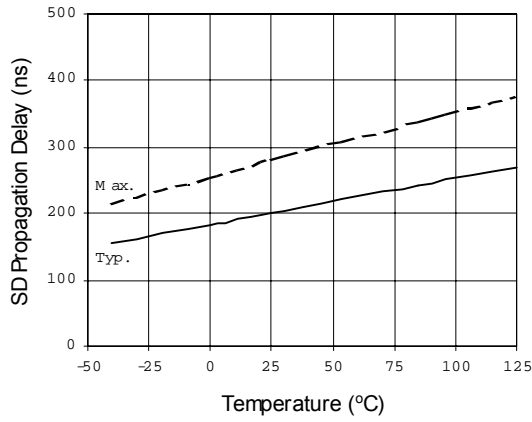


Figure 8A. SD Propagation Delay vs. Temperature

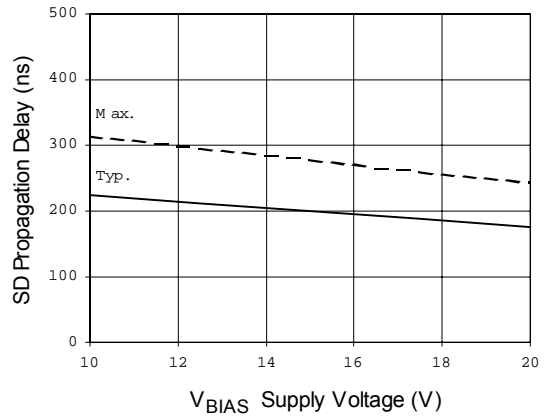


Figure 8B. SD Propagation Delay vs. Supply Voltage

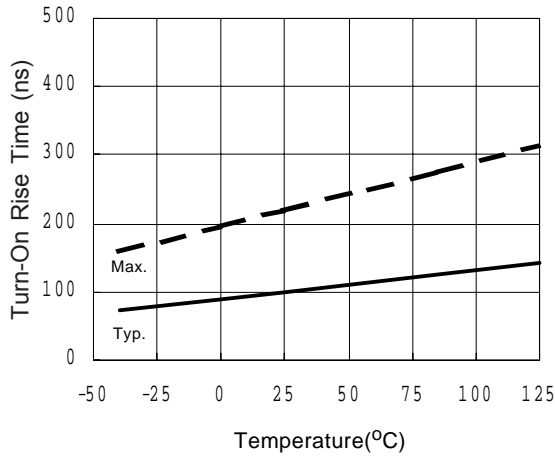


Figure 9A. Turn-On Rise Time vs. Temperature

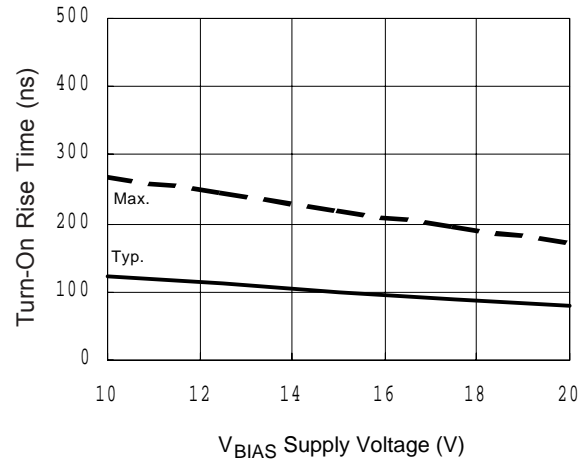


Figure 9B. Turn-On Rise Time vs. Supply Voltage

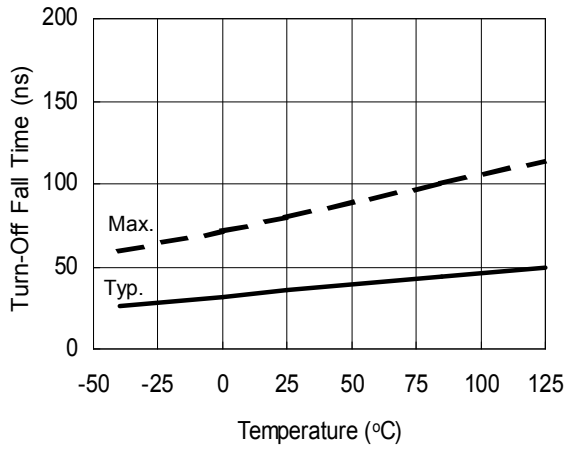


Figure 10A. Turn-Off Fall Time vs. Temperature

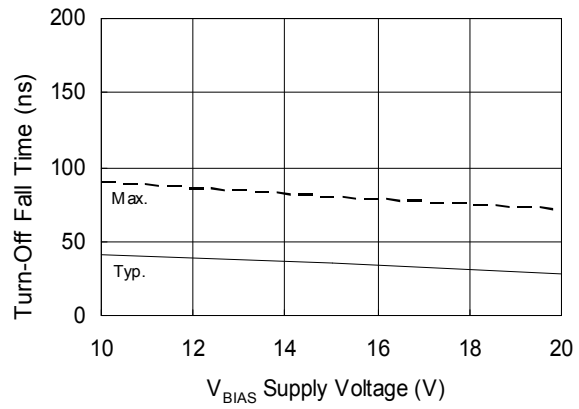


Figure 10B. Turn-Off Fall Time vs. Supply Voltage

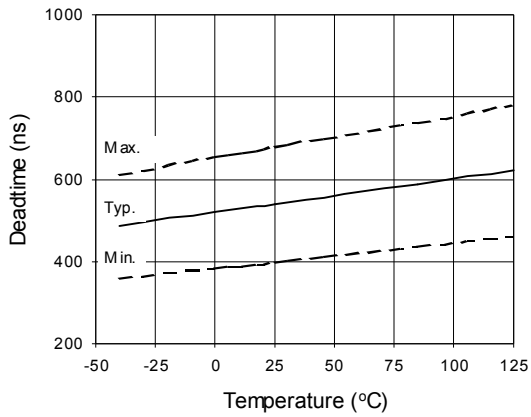


Figure 11A. Deadtime vs. Temperature

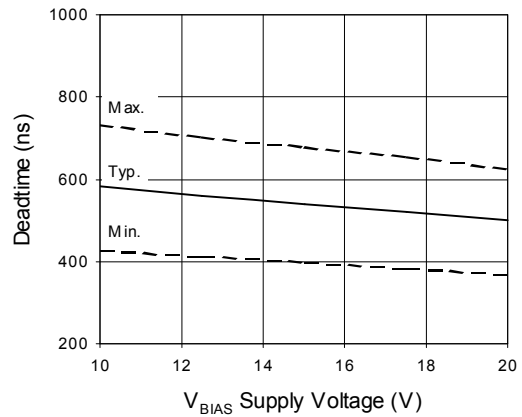


Figure 11B. Deadtime vs. Supply Voltage

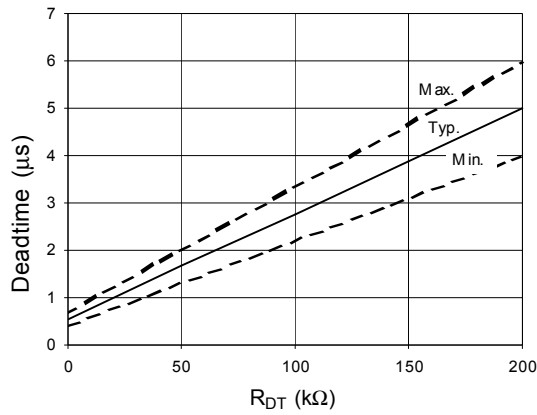


Figure 11C. Deadtime vs. R_{DT}

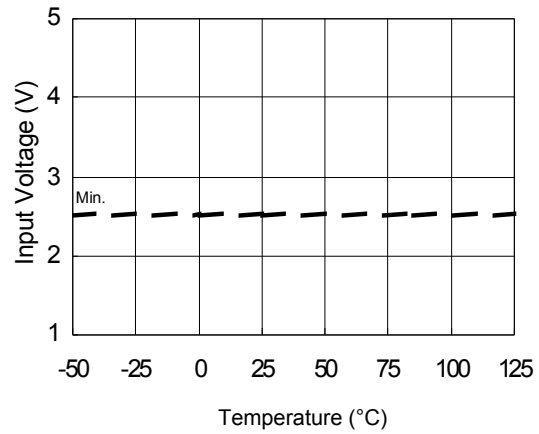


Figure 12A. Logic "1" Input Voltage vs. Temperature

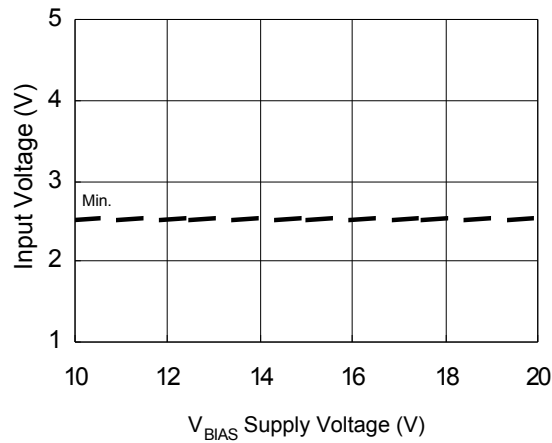


Figure 12B. Logic "1" Input Voltage vs. Supply Voltage

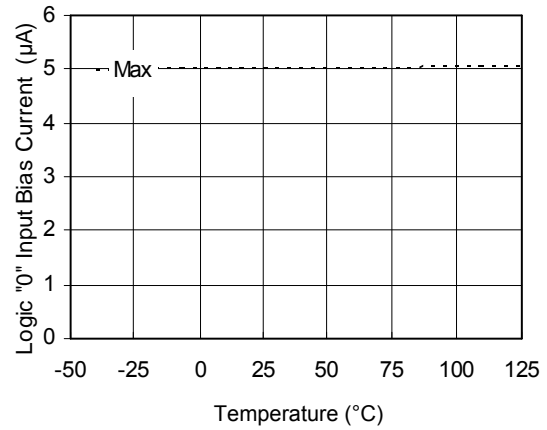


Figure 13A. Logic "0" Input Bias Current vs. Temperature

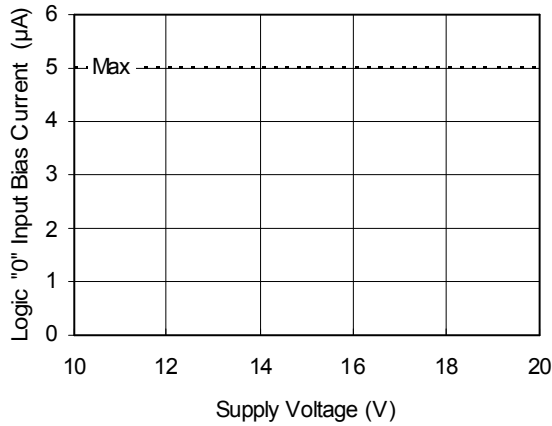


Figure 13B. Logic "0" Input Bias Current vs. Voltage

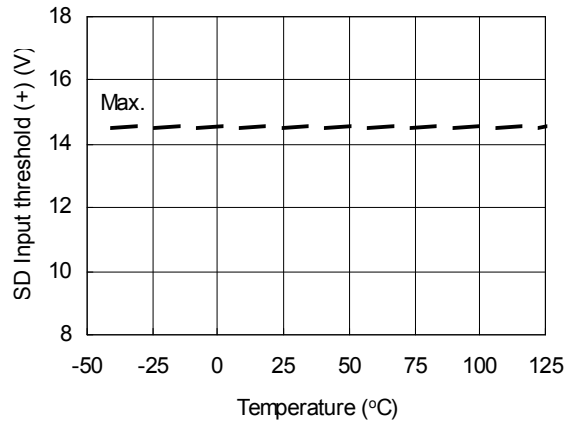


Figure 14A. SD Input Positive Going Threshold (+) vs. Temperature

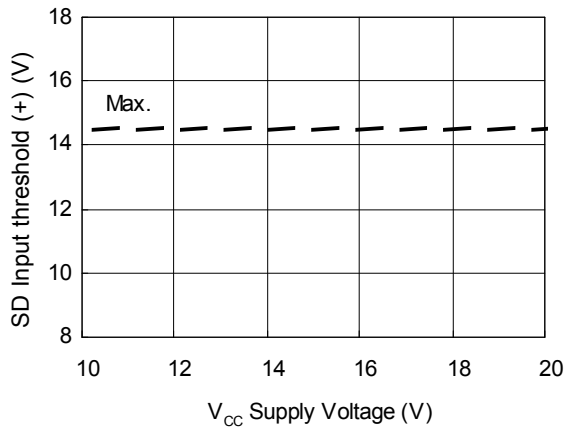


Figure 14B. SD Input Positive Going Threshold (+) vs. Supply Voltage

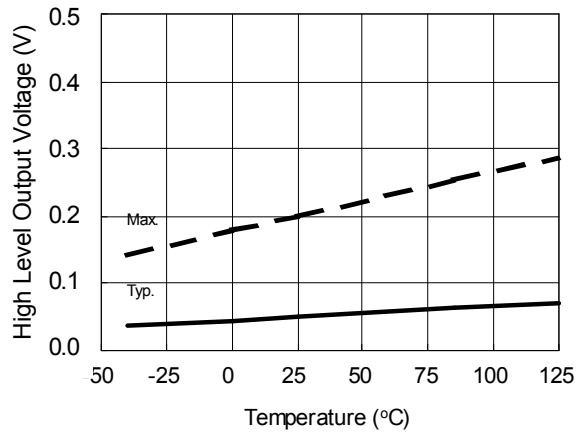


Figure 15A. High Level Output Voltage vs. Temperature

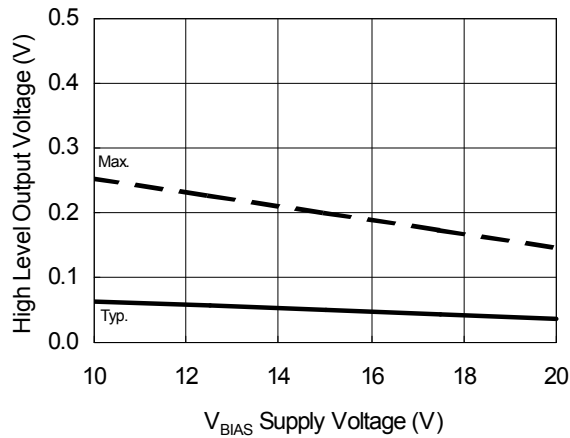


Figure 15B. High Level Output Voltage vs. Supply Voltage

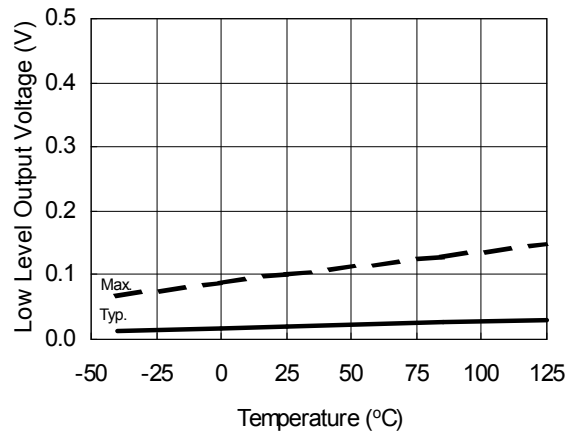


Figure 16A. Low Level Output Voltage vs. Temperature

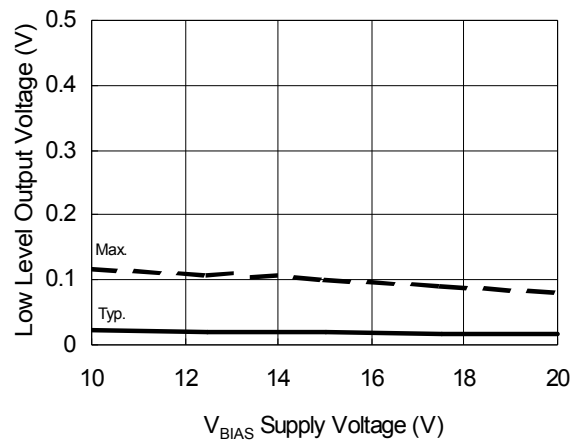


Figure 16B. Low Level Output Voltage vs. Supply Voltage

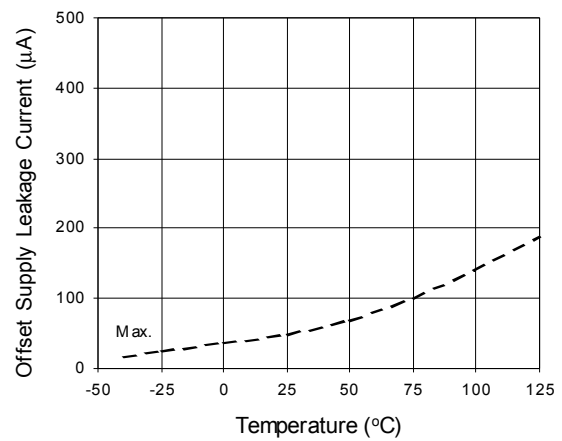


Figure 17A. Offset Supply Leakage Current vs. Temperature

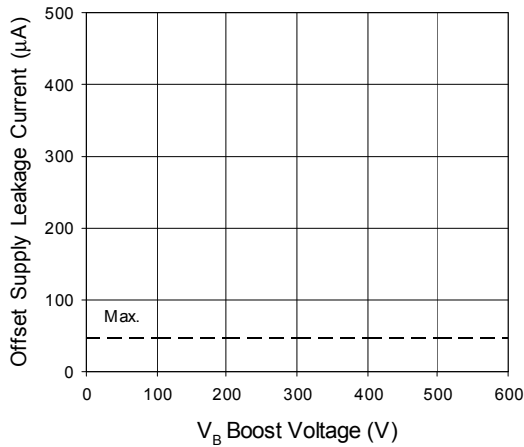


Figure 17B. Offset Supply Leakage Current vs. Boost Voltage

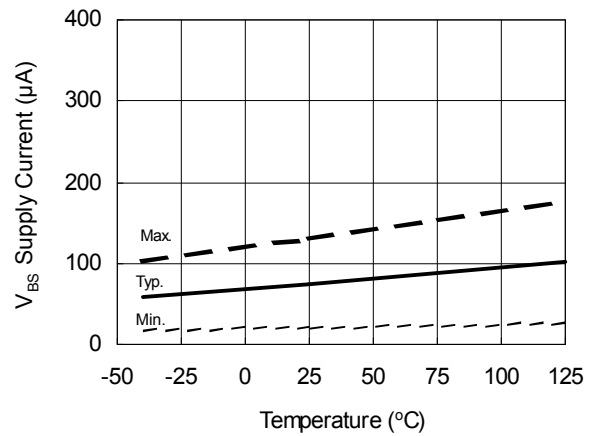


Figure 18A. V_{BS} Supply Current vs. Temperature

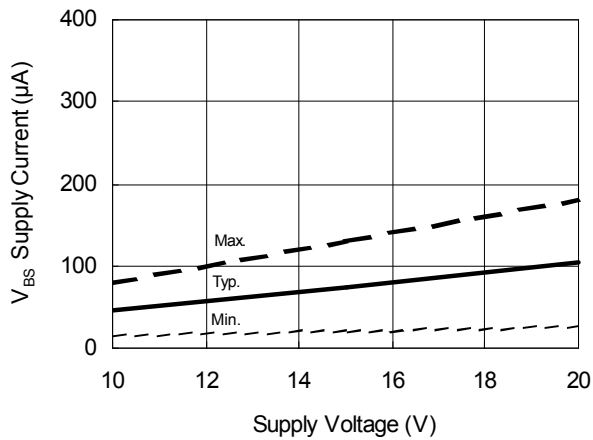


Figure 18B. V_{BS} Supply Current vs. Supply Voltage

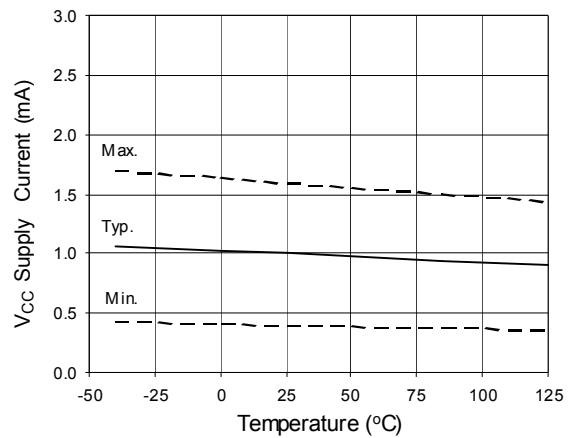


Figure 19A. V_{CC} Supply Current vs. Temperature

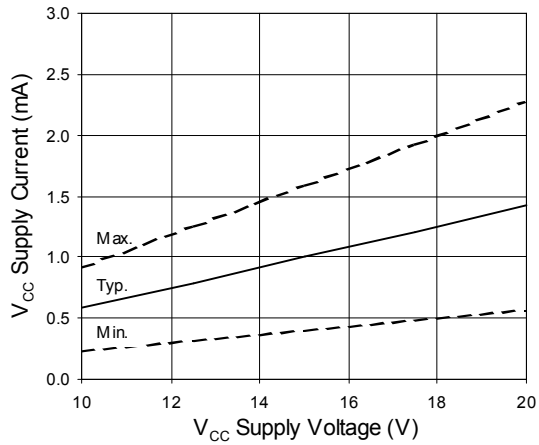


Figure 19B. V_{CC} Supply Current vs. V_{CC} Supply Voltage

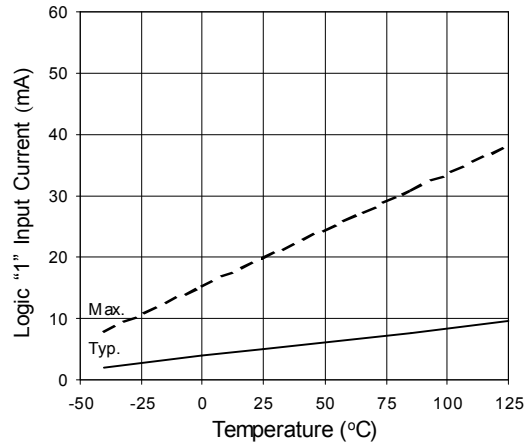


Figure 20A. Logic "1" Input Current vs. Temperature

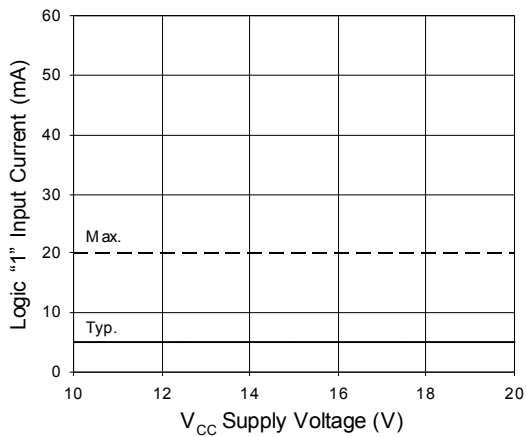


Figure 20B. Logic "1" Input Current vs. Supply Voltage

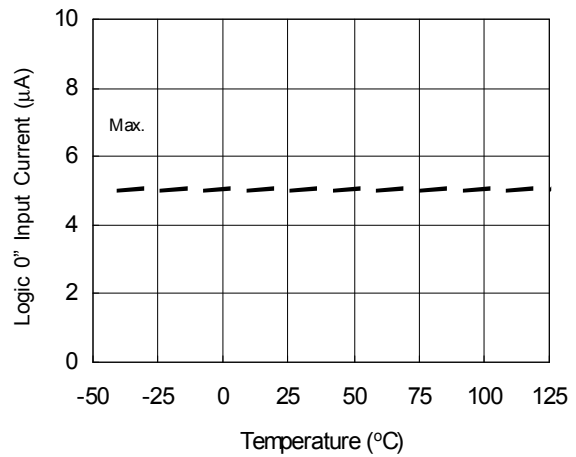


Figure 21A. Logic "0" Input Current vs. Temperature

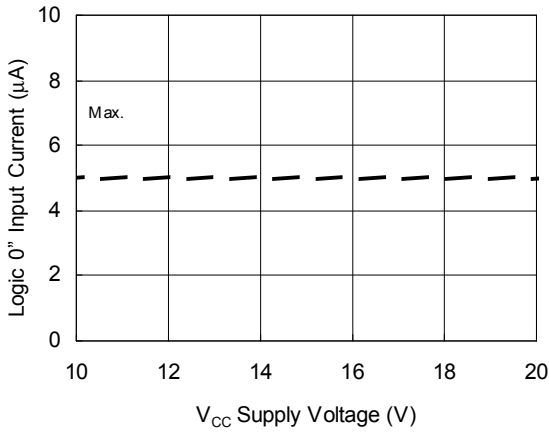


Figure 21B. Logic "0" Input Current vs. Supply Voltage

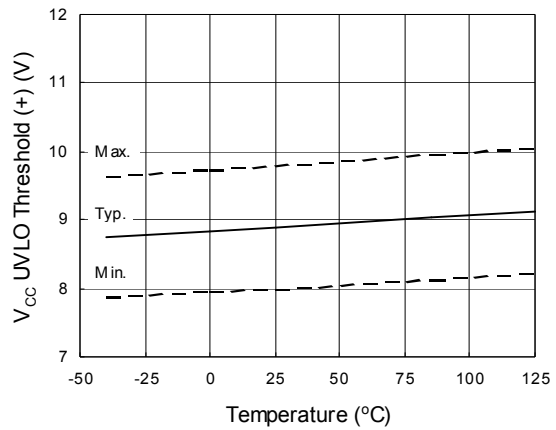


Figure 22. V_{CC} Undervoltage Threshold (+) vs. Temperature

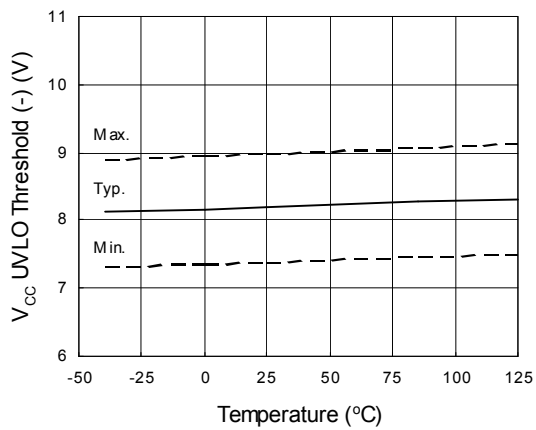


Figure 23. V_{CC} Undervoltage Threshold (-) vs. Temperature

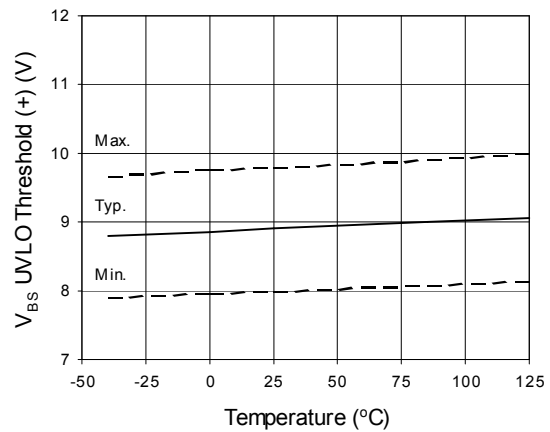


Figure 24. V_{BS} Undervoltage Threshold (+) vs. Temperature

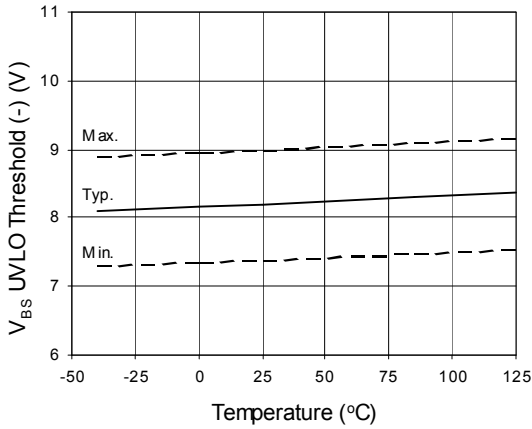


Figure 25. V_{BS} Undervoltage Threshold (-) vs. Temperature

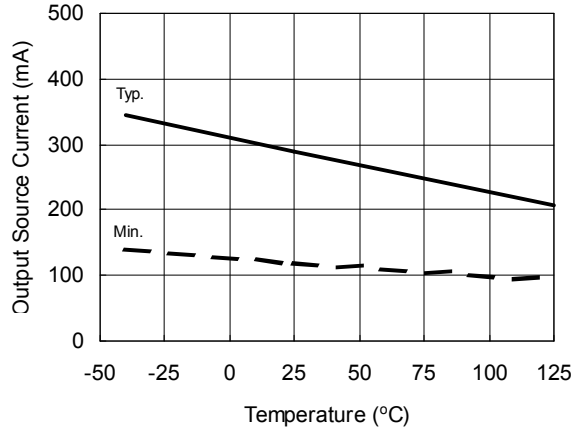


Figure 26A. Output Source Current vs. Temperature

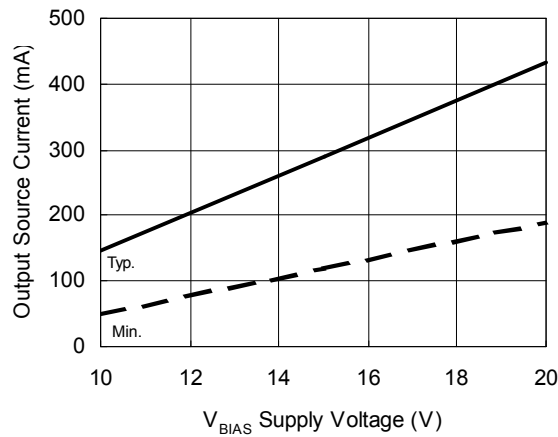


Figure 26B. Output Source Current vs. Supply Voltage

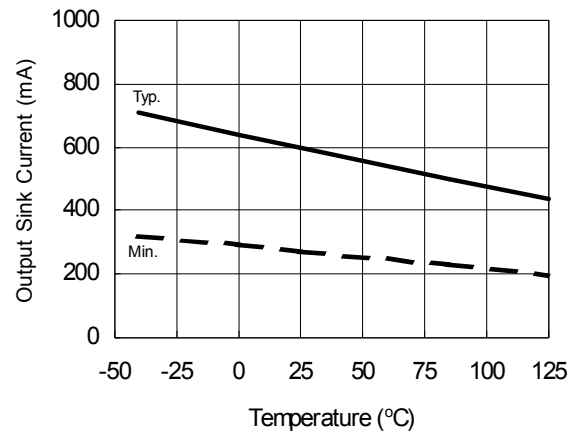


Figure 27A. Output Sink Current vs. Temperature

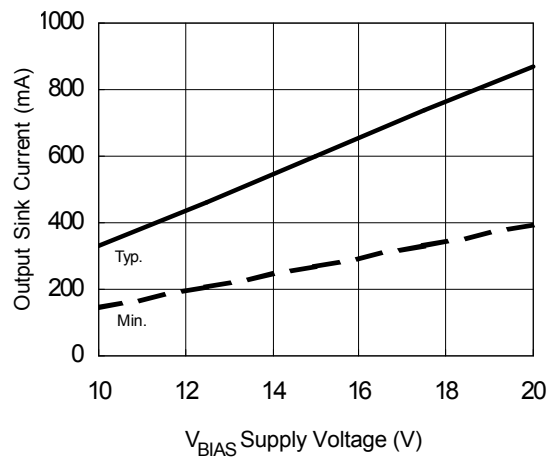


Figure 27B. Output Sink Current vs. Supply Voltage

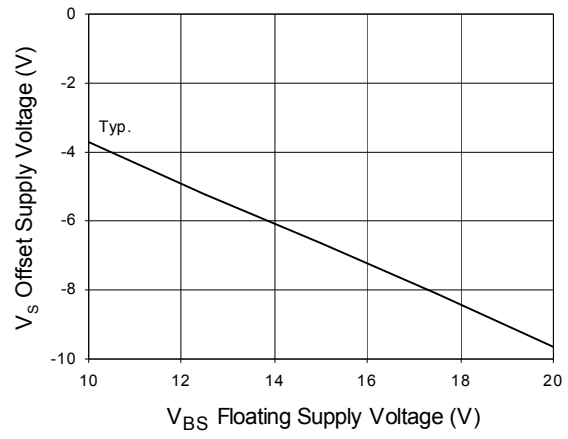
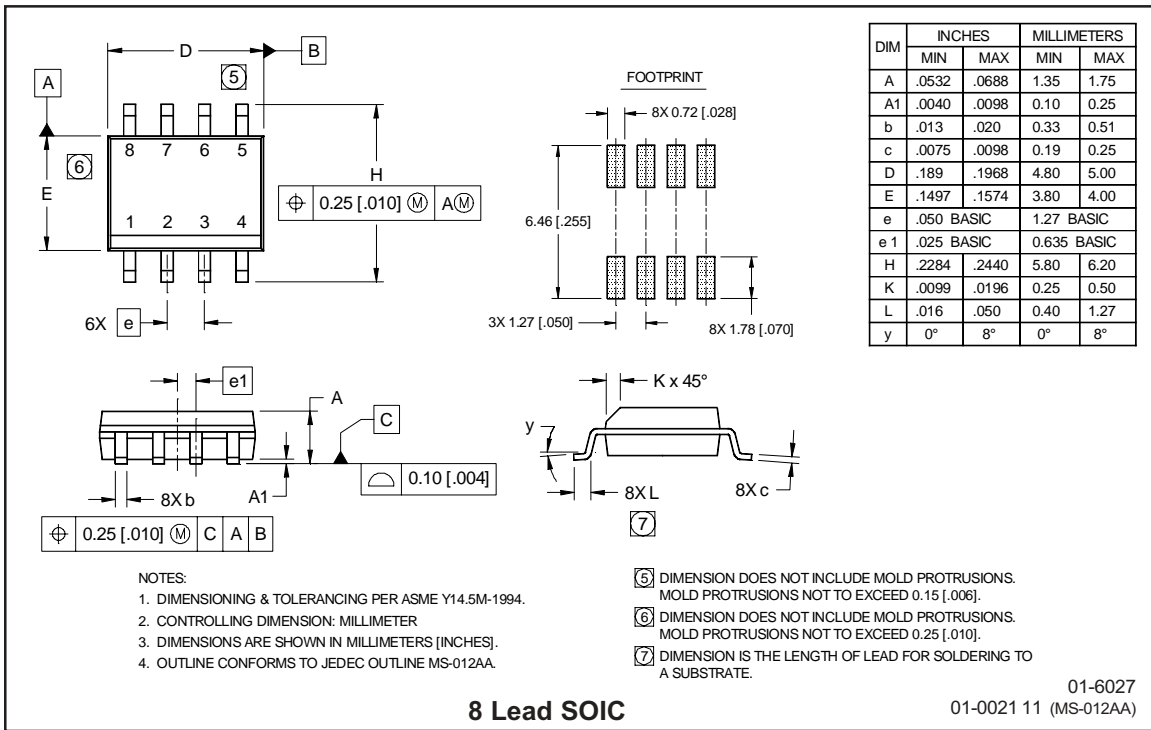
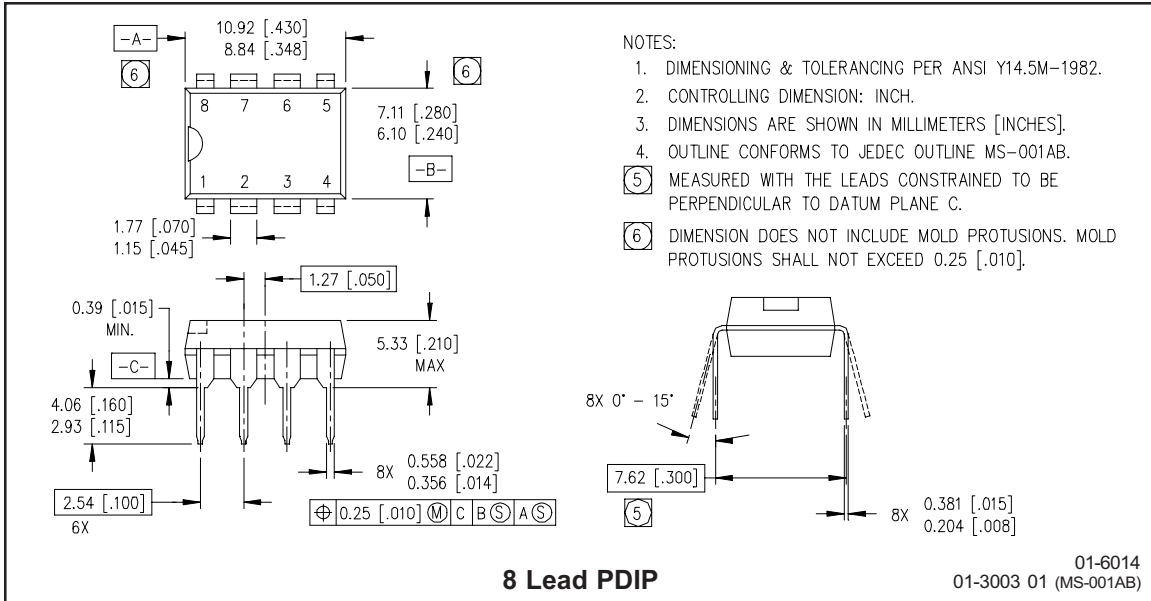
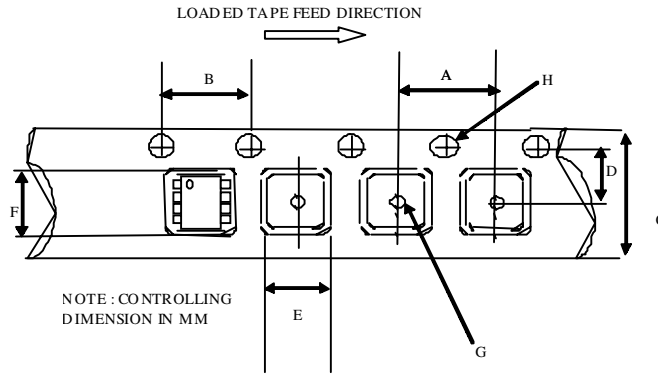


Figure 28. Maximum V_s Negative Offset vs. Supply Voltage

Case Outlines

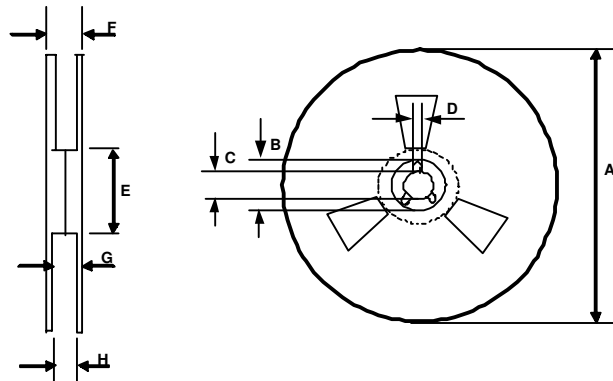


**Tape & Reel
8-lead SOIC**



CARRIER TAPE DIMENSION FOR 8SOICN

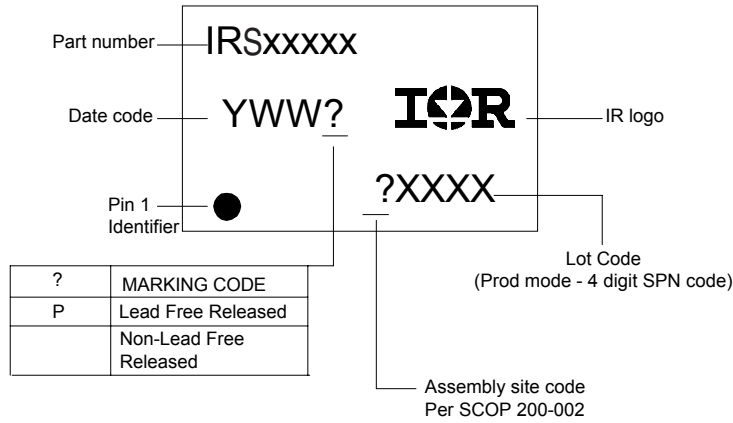
Code	Metric		Imperial	
	Min	Max	Min	Max
A	7.90	8.10	0.311	0.318
B	3.90	4.10	0.153	0.161
C	11.70	12.30	0.46	0.484
D	5.45	5.55	0.214	0.218
E	6.30	6.50	0.248	0.255
F	5.10	5.30	0.200	0.208
G	1.50	n/a	0.059	n/a
H	1.50	1.60	0.059	0.062



REEL DIMENSIONS FOR 8SOICN

Code	Metric		Imperial	
	Min	Max	Min	Max
A	329.60	330.25	12.976	13.001
B	20.95	21.45	0.824	0.844
C	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	18.40	n/a	0.724
G	14.50	17.10	0.570	0.673
H	12.40	14.40	0.488	0.566

LEADFREE PART MARKING INFORMATION



ORDER INFORMATION

- 8-Lead PDIP IRS21091PbF
- 8-Lead SOIC IRS21091SPbF
- 8-Lead SOIC Tape & Reel IRS21091STRPbF